

ROCCOR



Development of a lightweight thermal capacitor panel for thermal control of CubeSat applications

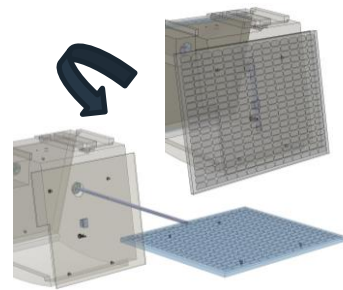
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roccor.com

Deployable Systems

Solar Array Deployment Systems,
Deployable Antenna, Magnetometers,
Specialist ProxOps deployable products

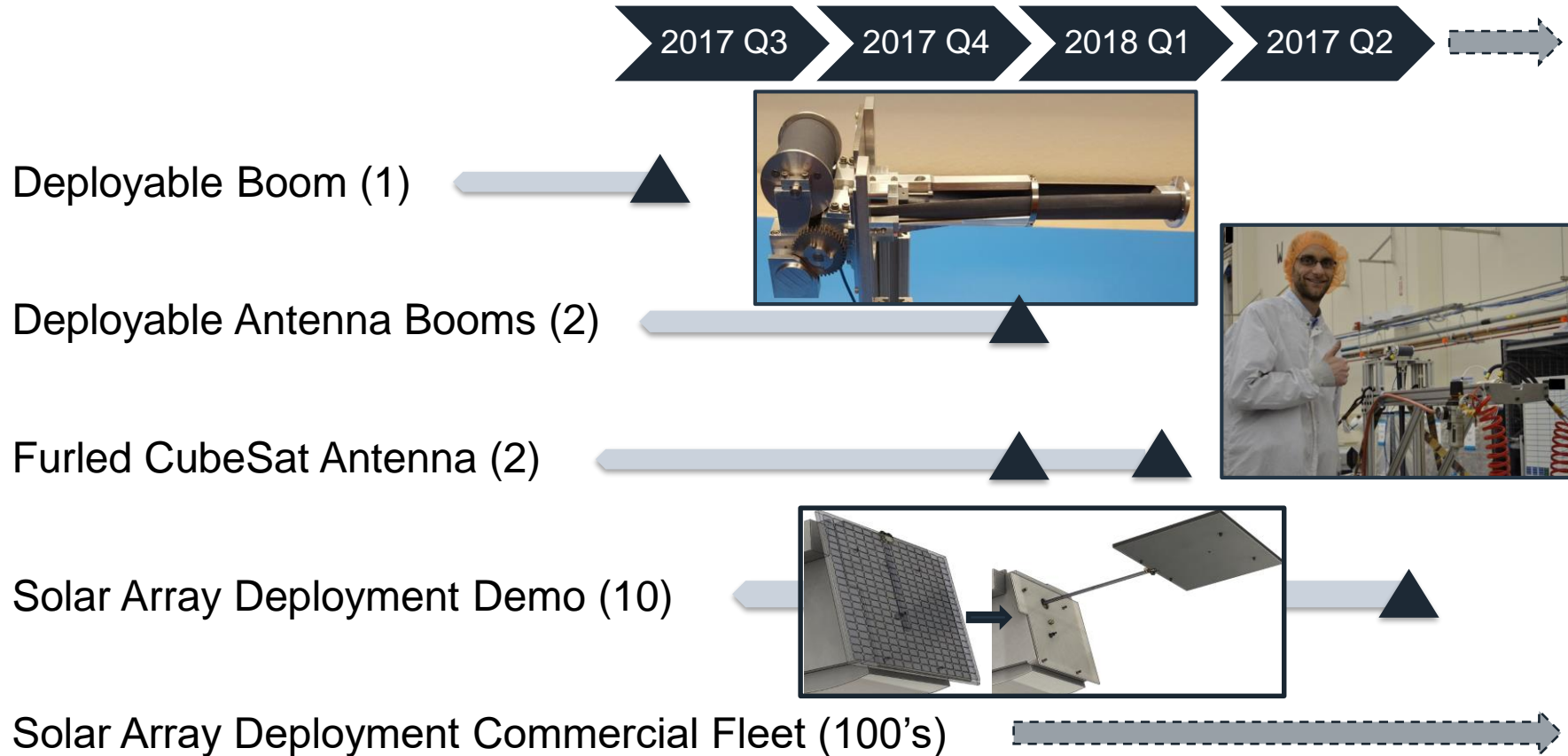
Custom high performance co-engineered deployable
devices

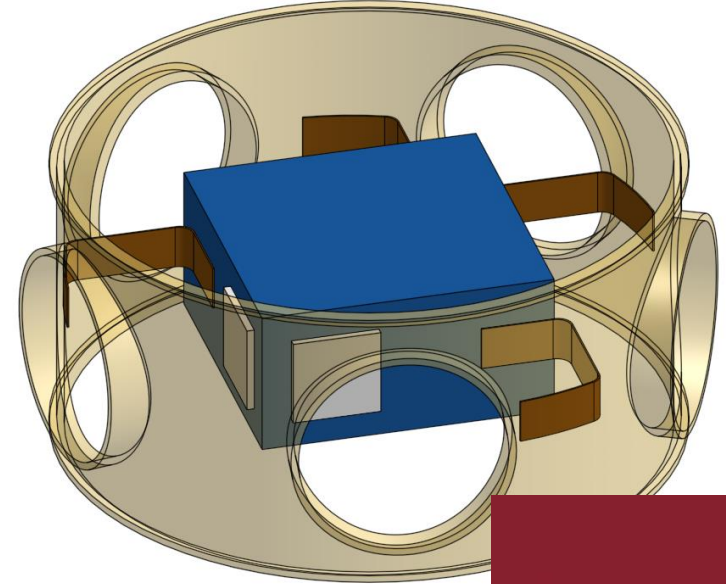
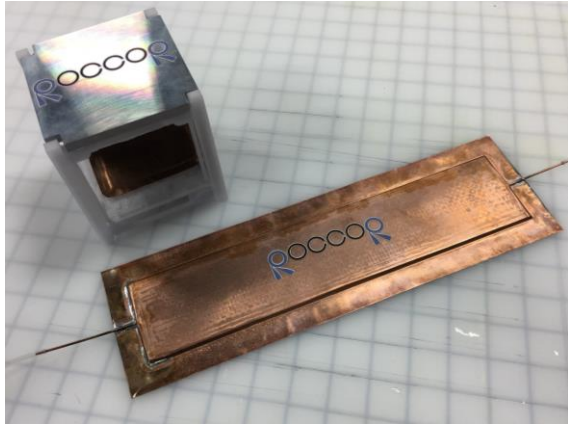


Thermal Management

Flat heat pipes, pumped two-phase
cooling and thermal capacitors

Two-Phase Electronic Cooling Product Technologies





MOOG
SPACE AND DEFENSE GROUP

**Thermal solutions for spacecraft in the
cubesat to 1,000kg class and beyond**

Why Two-Phase?

- **Benefits of two-phase flow:**

- » Volume and mass savings → SWaP improvement
- » Reduced mass flow rate
- » Lower pressure drops
- » Temperature uniformity among multiple heat sources
- » Able to cool several components in series

- **Additional benefits of Roccor's approach:**

- » Scalable manufacturing
- » Commercial-off-the-shelf materials
- » Design flexibility



10 cm x 10 cm Plain Copper at 120 W

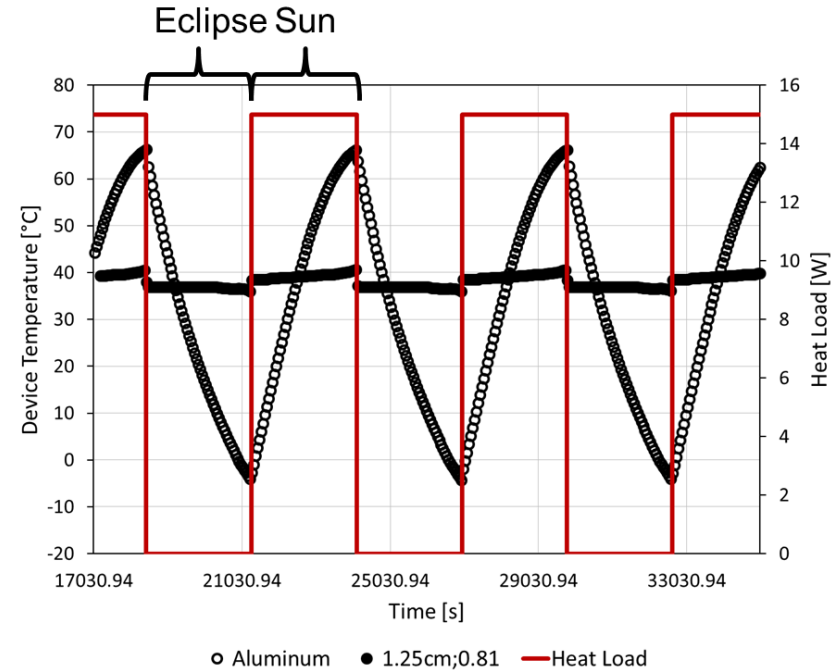
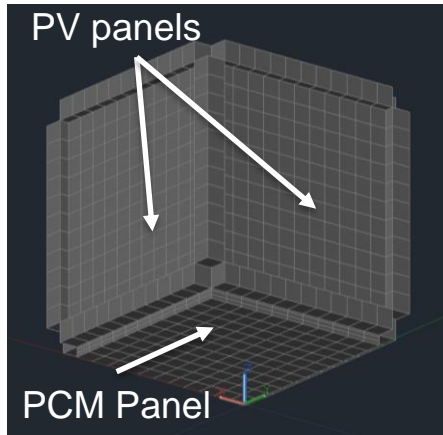


10 cm x 10 cm FlatCool at 120 W

Need for a thermal solution to dampen large temperature fluctuations

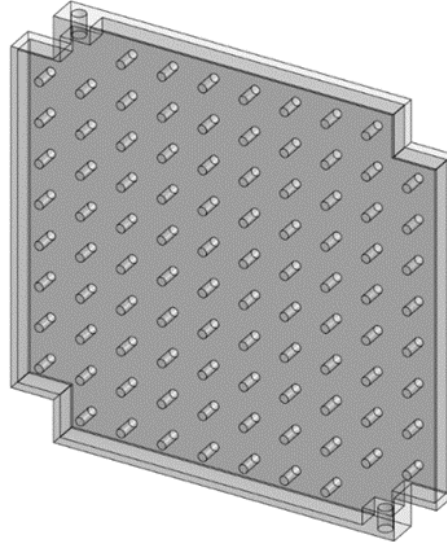
- **A Thermal Capacitor using Phase Change material:**

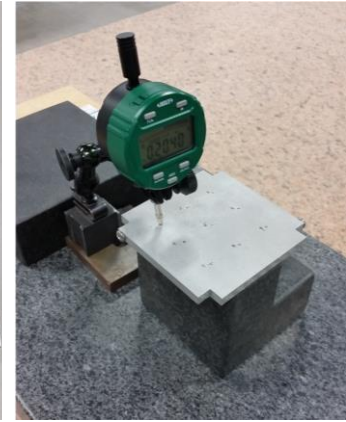
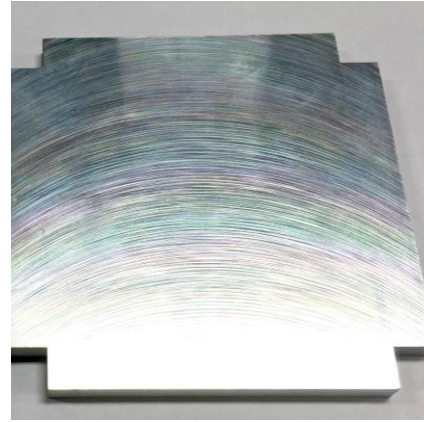
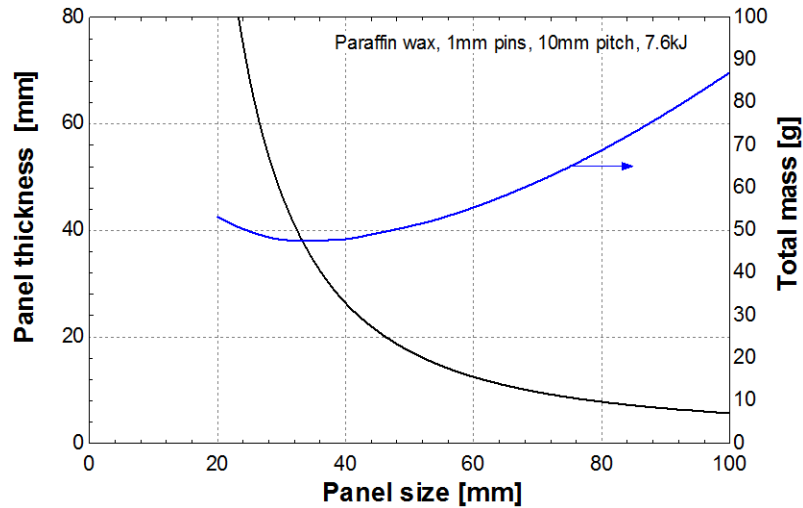
- » Can dampen temperature fluctuations to maintain components within a tolerable range
- » Can reduce large temperature swings that could lead to undesirable thermal stresses



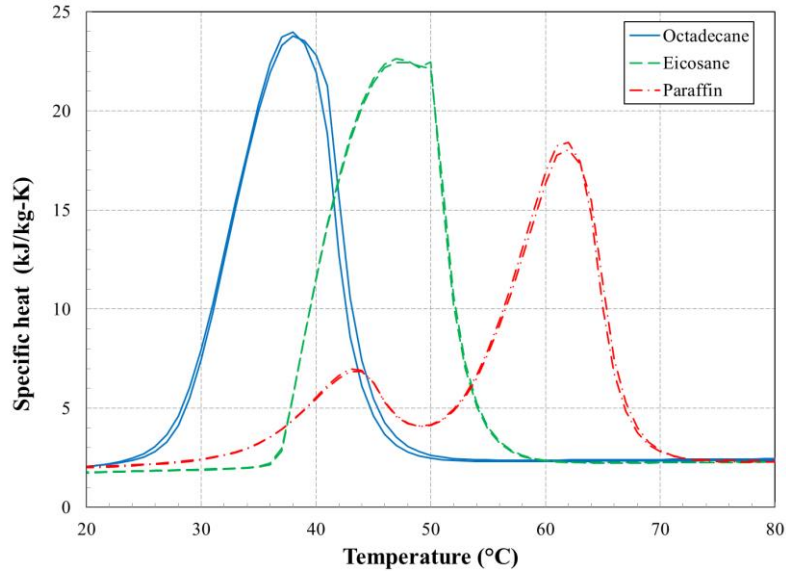
Thermal Capacitor built using 3D Printed Aluminum

- **Direct Laser Metal Sintering (DMLS)**
- **Internal structure:**
 - » Load bearing
 - » Thermal conductivity enhancement
- **Monolithic construction**
- **Filling ports**





- **Worked with DMLS manufacturers to identify minimum feature sizes, wall thickness, internal support structures, and filling ports**
- **Prototypes were within flatness specifications**
- **Prototypes can be post-processed for optical characteristics**



PCM	Latent Heat (kJ/kg)		Variance
	Literature	Experimental	
Octadecane	244.0	234.5	3.9%
Eicosane	247.3	237.2	4.1%

PCM	Thermal Conductivity (W/m-K)		Variance
	Literature	Experimental	
Octadecane (solid)	0.358	0.418	14%
Octadecane (liquid)	0.152	0.147	3%
Eicosane (liquid)	0.150	0.118	28%

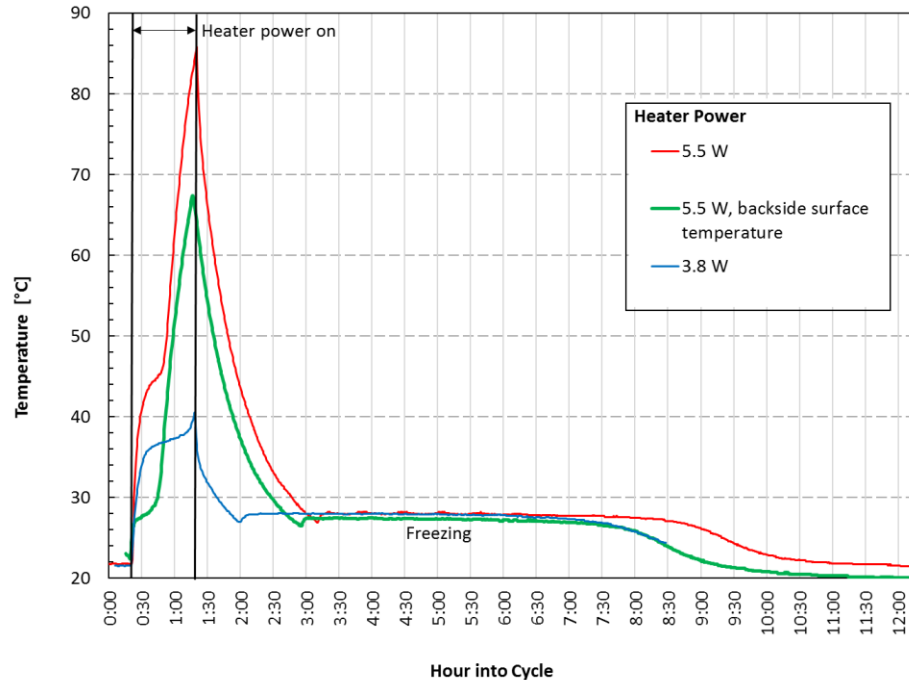
- **Measured specific heat (and latent heat) and thermal conductivity, to verify literature values:**

- » Differential scanning calorimeter testing for specific heat (at Netzsch)
- » Flash method test for thermal conductivity (at Netzsch)

- **Specific heat is within 5% of literature (measurement error)**

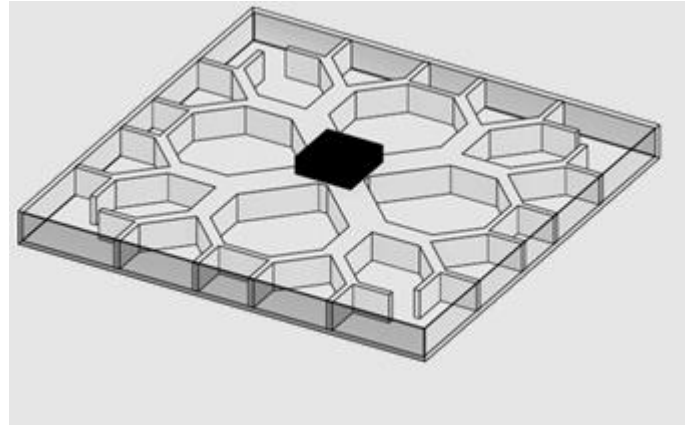
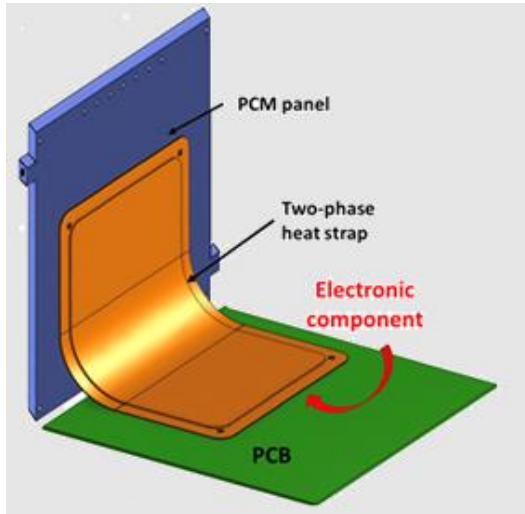
- **Conductivity can be 28% from literature**

- **Specific heat curve can be used in Thermal Desktop model**



- Panel was filled with PCM and sealed
- Performed thermal testing under vacuum
- Completed 25 freeze/thaw tests
- No degradation was observed (no panel deformation, melt temperature or mass change)

- Testing and analysis performed demonstrated the proof of concept
- Future designs will be tailored for a given set of requirements
- Future testing will incorporate FlexCool™ heat strap



Thank you and questions

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- »Stephanie Mauro and Jeff Farmer (NASA MSFC)
- »Professor Ben Malphrus, Kevin Brown, Yevgeniy Byelob (Morehead State University)
- »Dr. Boris Yendler (Insat Consulting)



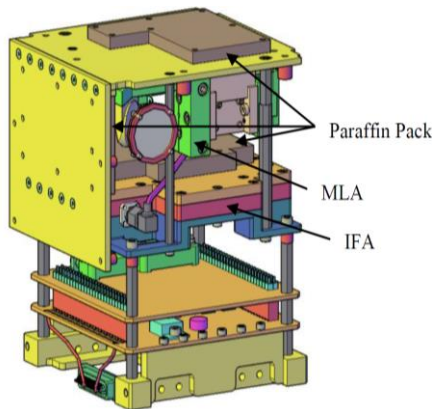
For more information please contact

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Other PCM Panel Solutions

Requirements	Value
Operating temperature	20°C
Thermal stability	$\pm 1^\circ\text{C}$
MLA power dissipation	3 W
Eclipse time	30 min
Thermal Energy	7.35 kJ
PCM Solution	
Material	n-Hexadecane
Melt temperature	18.2°C
PCM mass	31 g
Total mass	~46 g
Panel structure: Fine aluminum honeycomb core K1100 carbon fibers Aluminum frame	



PCM panel for NASA Vegetation Canopy Lidar (VCL) project

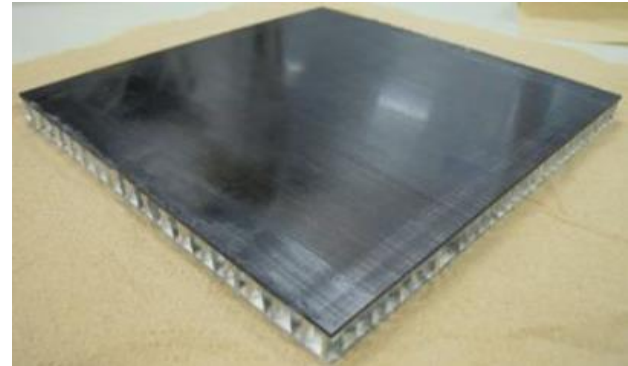
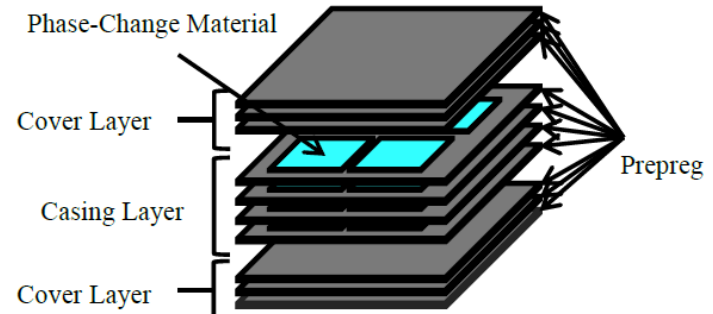
[Choi, M., 2015, "Paraffin Phase Change Material for Maintaining Temperature Stability of IceCube Type of CubeSats in LEO", presented at AIAA Propulsion and Energy Forum and Exposition]

Other PCM Panel Solutions

Requirements	Value
Thermal Energy	2.1 kJ
PCM Solution	
Material	Eicosane
Melt temperature	36.4°C
PCM mass	~10 g
Total mass	~100 g
Panel structure: Carbon fiber reinforced polymer	

Casing layers sized based on amount of PCM material and to reduce bending

[Yamada, K., and Nagano, H., 2014, "Heat Storage Panel Using a Phase-Change Material Encapsulated in a High-Thermal Conductivity CFRP for Micro Satellites", 44th International Conference on Environmental Systems.]



ROCCOR 
FlatCool™ Technology

- **Computational tools for design and analysis:**

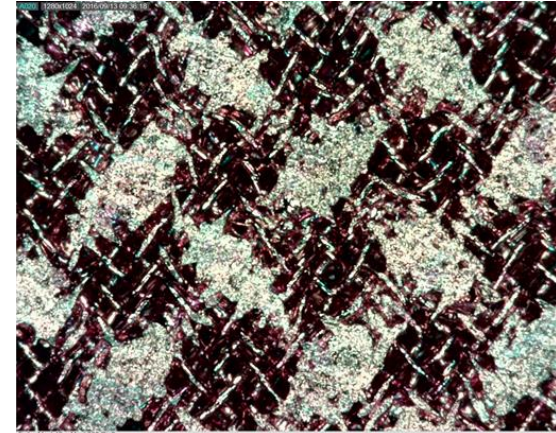
- » One-dimensional design models for flat heat pipes
- » CFD and FEA models for detailed analysis
- » Thermal Desktop analyses for space applications

- **Scalable manufacturing methods:**

- » Commercial off-the-shelf materials (metal woven meshes)
- » Diffusion bonding
- » 3D printing (direct metal laser sintering, stereolithography)

- **Ultra-omniphilic surface treatments:**

- » Based on collaboration with New Mexico State University
- » Increases capillary action and boiling of water on metal wicks



Diffusion Bonded Metal Woven Meshes